

Datasheet: 430927-W02

Macropores etched into n-Si substrate (5 Ohm*cm)

Etching

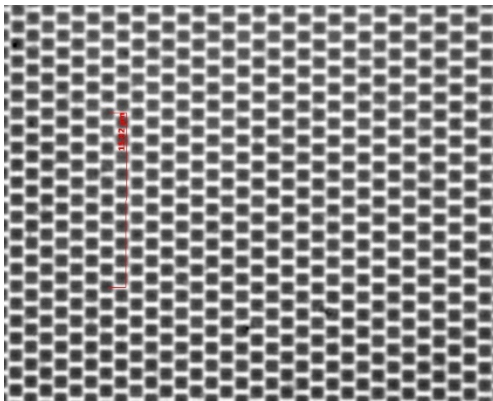
Size:	6 inch
Pitch:	4.2 μm trigonal
Length:	201 μm pore length (525 μm wafer thickness)
Shape:	straight
Diameter:	2-2.5 μm

Postprocessing

- Laserdicing 10 x 10 mm

Images

Top view



Side view

